



3x 2.4mm SMD CHIP LED LAMP

#### **Features**

- 3mm x 2.4mm SMT LED, 1.05mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE: 2000PCS/REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 3.
- Rohs Compliant.

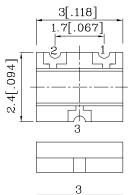


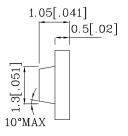


#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm$  0.20(0.008") unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (Ta=25°C)		MDK (InGaAlP)	Unit
Reverse Voltage	VR	5	V
Forward Current	IF	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	iFS	185	mA
Power Dissipation	Рт	75	mW
Operating Temperature	TA	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	-0





- 0.8
- 1. ANODE
- 2. N.C
- 3. CATHODE

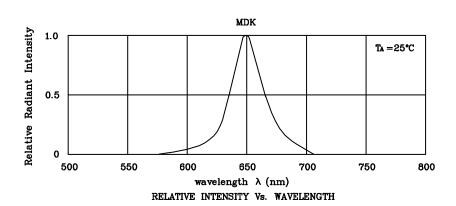
Operating Characteristic (TA=25°C)	MDK (InGaAlP)	Unit	
Forward Voltage (Typ.) (IF=20mA)	$V_{\mathrm{F}}$	1.95	V
Forward Voltage (Max.) (IF=20mA)	$V_{\rm F}$	2.5	V
Reverse Current (Max.) (VR=5V)	IR	10	uA
Wavelength of Peak Emission (Typ.) (IF=20mA)	λΡ	650	nm
Wavelength of Dominant Emission (Typ.) (IF=20mA)	λ D	635	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=20mA)	Δλ	28	nm
Capacitance (Typ.) (VF=0V, f=1MHz)	С	35	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		Wavelength nm λ P	Viewing Angle 2 0 1/2
				min.	typ.		
XZMDK85WA	Red	InGaAlP	Water Clear	50	148	650	120°
Published Date : J	AN 18,2008	Drawing 2	No : XDSA7453	V3	Check	ed : B.L.LIU	P.1/4

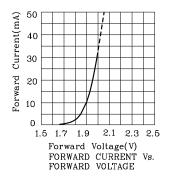


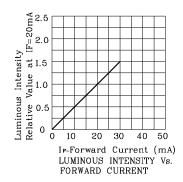
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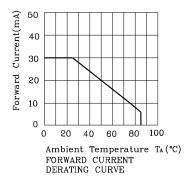


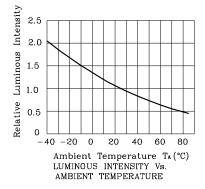


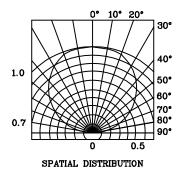
#### **❖** MDK









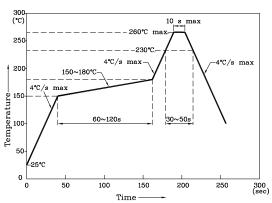


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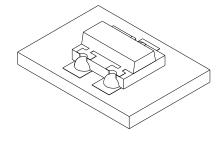
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Reflow Soldering Profile For Lead-free SMT Process.

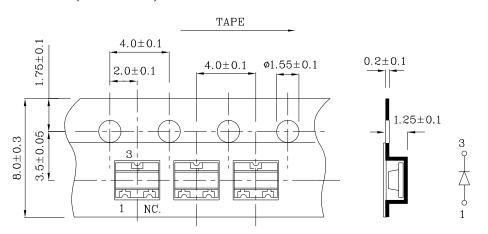


NOTES:

- Maximum soldering temperature should not exceed 260°c.
- 2. Recommended reflow temperature: 145°c-260°c.
- 3. Do not put stress to the epoxy resin during high temperatures conditions.
- **❖** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)
- ❖ The device has a single mounting surface. The device must be mounted according to the specifications.



❖ Tape Specification (Units:mm)



#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

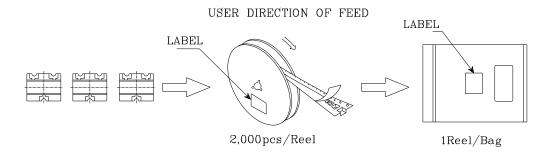


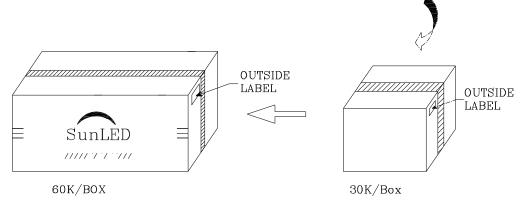
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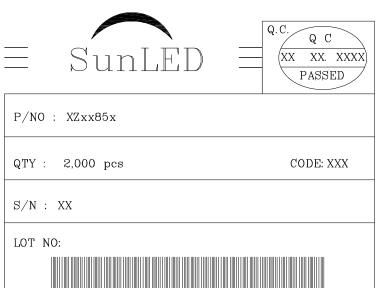


# PACKING & LABEL SPECIFICATIONS

#### XZMDK85WA







RoHS Compliant

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